			No.: Date:	RZC-K-HTS-0001 // 2017. 4. 21
		Data	sheet	
Title:		ED THICK FILM C PE ANDULTRAHIG		S; RECTANGULAR
Style:	RZ	C50, 63		
		AEC-Q2	200 qualified	
	-		PLIANCE ITEN d Antimony Fre	
		Product specification cor are subject to change at	5% Vithin 2 year from shipm Solderability shall be sa Itained in this data sh any time without notions s or a Purchasing Spo	tisfied. neet ce ecification for any quality



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND ULTRAHIGH VOLTAGE RZC50, 63

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1. Scope

- 1.1 This data sheet covers the detail requirements for fixed thick film chip resistors; rectangular type and ultrahigh voltage, style of RZC50, 63.
- 1.2 Applicable documents

JIS C 5201–1: 2011, JIS C 5201–8: 2014, JIS C 5201–8–1: 2014 IEC60115–1: 2008, IEC60115–8: 2009, IEC60115–8–1: 2014 EIAJ RC–2134C–2010

2. Classification

Type designation shall be the following form.

(Example)	RZC	63	_	475		J	TE		
	1	2	3	4		5	6		
	;	Style	-						
	1 Fixed t	hick film ch	ip resistors; re	ectangul	ar typ	be & ult	rahigh volta	age —	0.4
	2 Rated	dissipation	and / or dime	nsion					Style
	3 Tempe	rature coef	ficient of resis	tance					
	4 Rated	resistance	Example; 47	$75 \rightarrow 4.7$	7MΩ				
		475	E24 Series,	3 digit,	Ex.	475>	4.7MΩ,		
	5 Tolerar	nce on rate	d resistance					_	
		J	±5%						
		K	±10%						
		М	±20%						
	6 Packa	ging form		_					
		В	Bulk (loose p	backage	e)				
		TE	Embossed ta	aping					

3. Rating

3.1 The ratings shall be in accordance with Table-1.

				Table-1		
Style	Rated	Temperature of		Rated resistance	Preferred number	Tolerance on rated resistance
Cijie	dissipation (W)	resistance (10 ^{-°} / °C)	range (Ω)	Series for resistors	
RZC50	0.5	Standard	+200	1M~16M	E24	$1(\pm 6)$ $1(\pm 10)$ $1(\pm 20)$
RZC63	1.0	Slanuaru	±200		L24	J(±5%), K(±10%), M(±20%)

- . .

Style	Limiting element voltage (V)	Isolation voltage (V)	Category temperature range (°C)
RZC50	1500	500	EE 12E
RZC63	2000	500	-55~+125

3.2 Climatic category 55/125/56

Lower category temperature	− 55 °C
Upper category temperature	+125 °C
Duration of the damp heat, steady state test	56days

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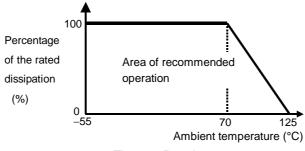
3.3 Stability class

5%

Limits for change of resistance:-for long-term tests $\pm(5\%+0.1\Omega)$ -for short-term tests $\pm(1\%+0.05\Omega)$

3.4 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.





3.5 Rated voltage

d. c. or a. c. r. m. s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

 $E = \sqrt{P \cdot F}$

E : Rated voltage (V) P : Rated dissipation (W) R : Rated resistance (Ω)

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

Symbol	Pac	Standard packaging quantity / units	
В	Bulk (loose package)	1,000 pcs.	
TE	Embossed taping	12mm width, 4mm pitches	4,000 pcs.

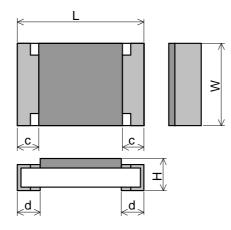
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FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND Title: **ULTRAHIGH VOLTAGE** RZC50, 63

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5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.





		Ur	nit : mm		
Style	L	W	Н	С	d
RZC50	5.0 ± 0.15	2.5 ± 0.15	0.55 ± 0.15	0.6 ± 0.2	0.6 ± 0.2
RZC63	6.3 ± 0.15	3.2 ± 0.15	0.55 ± 0.15	0.6 ± 0.2	0.6 ± 0.2

5.2 Net weight (Reference)

Style	Net weight(mg)
RZC50	25
RZC63	40

6. Marking

The Rated resistance shall be marked in 3 digits (E24) and marked on over coat side. (Example) "475" \rightarrow 47 ×10 ⁵[Ω] \rightarrow 4.7 [M Ω]

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Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND ULTRAHIGH VOLTAGE RZC50, 63

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7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201-1: 2011

7.2 The performance shall be satisfied in Table-4.

		Table-4(1)	
No.	Test items	Condition of test (JIS C 5201–1)	Performance requirements
1	Visual examination	Sub–clause 4.4.1 Checked by visual examination.	As in 4.4.1 The marking shall be legible, as checked by visual examination.
2	Dimension Resistance	Sub–clause 4.4.2 Sub–clause 4.5	As specified in Table–3 of this specification. As in 4.5.2 The resistance value shall correspond with the rated resistance taking into account the specified tolerance.
3	Voltage proof	Sub-clause 4.7 Method: 4.6.1.4(See Figure-5) Test voltage: Alternating voltage with a peak value of 1.42 times the insulation voltage. Duration: $60 \text{ s} \pm 5 \text{ s}$ Insulation resistance Test voltage: Insulation voltage Duration: 1 min.	No breakdown or flash over $R \ge 1 \ G \ \Omega$
4	Solderability	Sub-clause 4.17 Without ageing Flux: The resistors shall be immersed in a non-activated soldering flux for 2s. Bath temperature: $235 \degree C \pm 5 \degree C$ Immersion time: $2 \ s \pm 0.5 \ s$	As in 4.17.4.5 The terminations shall be covered with a smooth and bright solder coating.
5	Mounting Overload (in the mounted state)	Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3 Sub-clause 4.13 The applied voltage shall be 2.5 times the rated voltage or twice the limiting element voltage which ever is less severe. Duration: 2 s Visual examination Resistance Sub-clause 4.30	No visible damage $\Delta R \leq \pm (1\%+0.05\Omega)$
	Solvent resistance of the marking	Sub-clause 4.30 Solvent: 2–propanol Solvent temperature: 23 °C ± 5 °C Method 1 Rubbing material: cotton wool Without recovery	Legible marking

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		Table-4(2)	
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
6	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
		Test substrate: Figure–4	
	Bound strength of the end	Sub–clause 4.33	
	face plating	Bent value: 1 mm	
		Resistance	∆R ≤ ± (1%+0.05Ω)
	Final measurements	Sub–clause 4.33.6	
		Visual examination	No visible damage
7	Resistance to soldering heat	Sub–clause 4.18	
		Solvent temperature: 260 °C \pm 5 °C	
		Immersion time: $5 s \pm 0.5 s$	
		Visual examination	As in 4.18.3.4
			No sign of damage such as cracks.
		Resistance	ΔR ≤ ± (1%+0.05Ω)
	Component solvent	Sub–clause 4.29	
	resistance	Solvent: 2–propanol	
		Solvent temperature: 23 °C ± 5 °C	
		Method 2	
		Recovery: 48 h	
		Visual examination	No visible damage
		Resistance	ΔR≤±(1%+0.05Ω)
8	Mounting	Sub–clause 4.31	
		Substrate material: Epoxide woven glass	
		Test substrate: Figure–3	
	Adhesion	Sub–clause 4.32	
		Force: 5 N	
		Duration: $10 s \pm 1 s$	
		Visual examination	No visible damage
	Rapid change temperature	Sub–clause 4.19	
		Lower category temperature:	
		_55 ℃	
		Upper category temperature:	
		+125 °C	
		Duration of exposure at each temperature: 30	
		min.	
		Number of cycles: 5 cycles.	Ne visible deves as
		Visual examination	No visible damage
		Resistance	ΔR ≤ ±(1%+0.05Ω)

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		Table-4(3)	
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
9	Climatic sequence –Dry heat	Sub–clause 4.23 Sub–clause 4.23.2	
		Test temperature: +125 °C Duration: 16 h	
	–Damp heat, cycle	Sub-clause 4.23.3	
	(12+12hour cycle)	Test method: 2	
	First cycle	Test temperature: 55 °C [Severity(2)]	
	Cold	Sub-clause 4.23.4	
		Test temperature –55 °C Duration: 2h	
	–Damp heat, cycle	Sub-clause 4.23.6	
	(12+12hour cycle)	Test method: 2	
	Remaining cycle	Test temperature: 55 °C	
		[Severity (2)]	
		Number of cycles: 5 cycles	
	–D.C. load	Sub-clause 4.23.7	
		The applied voltage shall be the rated voltage	
		or the limiting element voltage which ever is the smaller.	
		Duration: 1 min.	
		Visual examination	No visible damage
		Resistance	ΔR ≤ ± (5%+0.1Ω)
10	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
		(RZC63 may use Alumina substrate.) Test substrate: Figure–3	
	Endurance at 70 °C	Sub-clause 4.25.1	
		Ambient temperature: 70 °C \pm 2 °C	
		Duration: 1000 h	
		The voltage shall be applied in cycles of 1.5 h on and 0.5 h.	
		The applied voltage shall be the rated voltage	
		or the limiting element voltage which ever is	
		the smaller.	
		Examination at 48 h , 500 h and 1000 h:	
		Visual examination	No visible damage
		Resistance	$\Delta R \leq \pm (5\% + 0.1\Omega)$
11	Mounting	Sub-clause 4.31	
	Ŭ	Substrate material: Epoxide woven glass	
		Test substrate: Figure-3	
	Variation of resistance with	Sub-clause 4.8	As in Table–1
	temperature	-55 °C / +20 °C	
		+20 °C / +125°C	

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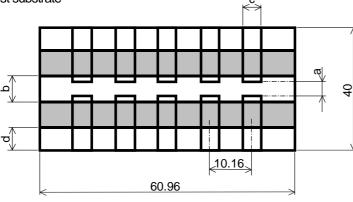
Table-4(4)								
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements					
12	Mounting	Sub–clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3						
Damp heat, steady state		 Sub-clause 4.24 Ambient temperature: 40 °C ± 2 °C Relative humidity : 93 ⁺²/₋₃ % a) 1st group: without voltage applied. b) 2nd group: The d. c. voltage shall be applied continuously. The voltage shall be accordance with Sub-clause 4.24.2.1 b). without polarizing voltage [4.24.2.1, c)] Visual examination 	No visible damage Legible marking					
		Resistance	ΔR ≤ ± (5%+0.1Ω)					
13	Dimensions (detail)	Sub-clause 4.4.3	As in Table-3					
	Mounting	Sub–clause 4.31 Substrate material: Epoxide woven glass						
	Endurance at upper category temperature	Test substrate: Figure–3 Sub–clause 4.25.3 Ambient temperature:125 °C ± 2 °C Duration: 1000 h Examination at 48 h, 500 h and 1000 h: Visual examination Resistance	No visible damage $\Delta R \leq \pm (5\%+0.1\Omega)$					
14	Mounting	Sub–clause 4.31 Substrate material: Epoxide woven glass						
	Anti-rush voltage test	Test substrate: Figure–3 Ambient temperature: $25^{\circ}C \pm 2^{\circ}C$ The voltage shall be applied in cycles of 1 s "ON", 9 s "OFF". Test voltage: 3000V Visual examination Resistance	No visible damage $\Delta R \leq \pm (1\%+0.05\Omega)$					

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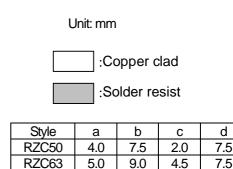


Figure-3 RZC50, 63 TEST SUBSTRATE

Remark 1). Material: Epoxide woven glass

Thickness: 1.6mm Thickness of copper clad: 0.035mm

2). In the case of connection by connector, the connecting terminals are gold plated. However, the plating is not necessary when the connection is made by soldering.

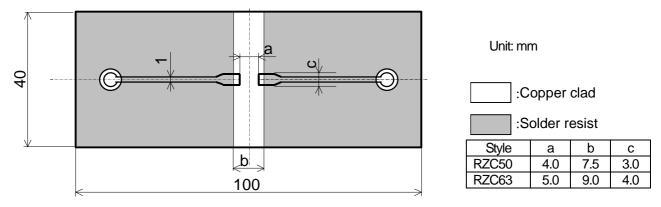
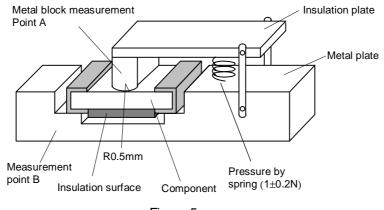


Figure-4 RZC50, 63 BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE

Remark 1). Material: Epoxide woven glass

Thickness: 1.6mm Thickness of copper clad: 0.035mm





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9. Taping

9.1 Applicable documents JIS C 0806–3: 2014, EIAJ ET–7200C: 2010

9.2 Taping dimensions

Embossed taping dimensions shall be in accordance with Figure-6 and Table-5.

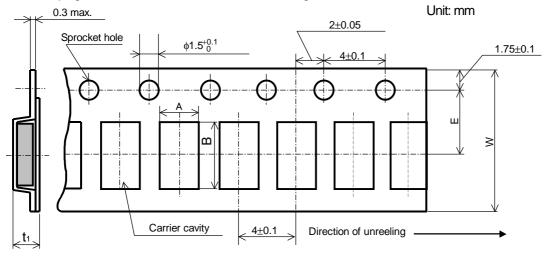
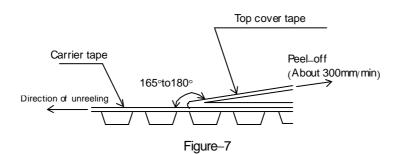


Figure-6							
	Unit: mm						
Style	Α	В	W	Е	t 1		
RZC50	3.1±0.2	5.5±0.2	12.0 <u>+</u> 0.3	5.5±0.05	1.1±0.15		
RZC63	3.6±0.2	6.9±0.2	12.0±0.3	5.5±0.05	1.1±0.15		

- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following Figure-7.
- 6). When the tape is bent with the minimum radius for 30 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.
- The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.



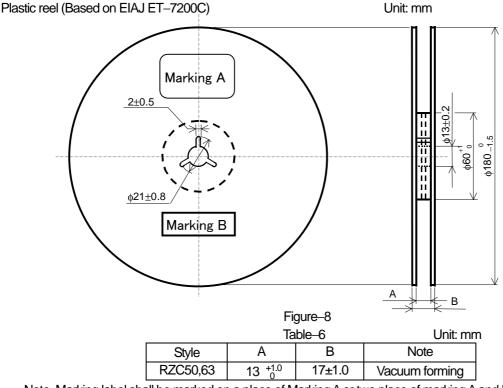
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9.3 Reel dimension

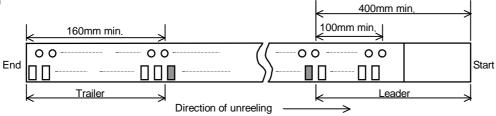
Reel dimensions shall be in accordance with the following Figure–8 and Table–6.



Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

9.4 Leader and trailer tape.

(Example)





10. Marking on package

The label of a minimum package shall be legibly marked with follows.

10.1 Marking A

(1) Classification (Style, Rated resistance, Tolerance on rated resistance, Packaging form)

- (2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others
- 10.2 Marking B (KAMAYA Control label)

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